SiHA20N50E

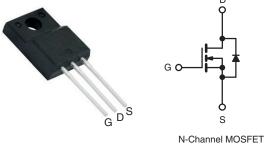




E Series Power MOSFET

PRODUCT SUMMARY				
V _{DS} (V) at T _J max.	550			
R _{DS(on)} max. at 25 °C (Ω)	$V_{GS} = 10 V$	0.184		
Q _g max. (nC)	92			
Q _{gs} (nC)	10			
Q _{gd} (nC)	19			
Configuration	Single			

Thin-Lead TO-220 FULLPAK



FEATURES

- Low figure-of-merit (FOM) Ron x Qg
- Low input capacitance (C_{iss})
- Reduced switching and conduction losses
- Low gate charge (Q_q)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Computing
 - PC silver box / ATX power supplies
- Lighting
 - Two stage LED lighting
- Consumer electronics
- Applications using hard switched topologies
 - Power factor correction (PFC)
 - Two switch forward converter
 - Flyback converter
- Switch mode power supplies (SMPS)

ORDERING INFORMATION	
Package	Thin-Lead TO-220 FULLPAK
Lead (Pb)-free	SiHA20N50E-E3

PARAMETER		SYMBOL	LIMIT	UNIT
Drain-Source Voltage		V _{DS}	500	
Gate-Source Voltage		N/	± 20	V
Gate-Source Voltage AC (f > 1 Hz)	V _{GS}	30		
Continuous Drain Current (T _J = 150 °C) $^{\rm e}$	V_{GS} at 10 V $T_C = 25 \degree C$		19	
	$T_{\rm C} = 100 ^{\circ}{\rm C}$	ID	12	А
Pulsed Drain Current ^a	I _{DM}	42		
Linear Derating Factor			1.4	W/°C
Single Pulse Avalanche Energy ^b		E _{AS} 204		mJ
Maximum Power Dissipation		PD	34	W
Operating Junction and Storage Temperature Range		T _J , T _{stg}	-55 to +150	°C
Drain-Source Voltage Slope	$V_{DS} = 0 V \text{ to } 80 \% V_{DS}$	-1) (/-1+	70	
Reverse Diode dV/dt ^d		dV/dt	32	V/ns
Soldering Recommendations (Peak Temperature) ^c	for 10 s		300	°C

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature.
- b. V_{DD} = 50 V, starting T_J = 25 °C, L = 28.2 mH, R_g = 25 $\Omega,$ I_{AS} = 3.8 A.
- c. 1.6 mm from case.
- d. $I_{SD} \leq I_D, \, dI/dt$ = 100 A/µs, starting T_J = 25 °C.
- e. Limited by maximum junction temperature.

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COMPLIANT



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THERMAL RESISTANCE RAT	INGS	1						
PARAMETER	SYMBOL	TYP.		MAX.		UNIT		
Maximum Junction-to-Ambient	R _{thJA}	- 65			°C/W			
Maximum Junction-to-Case (Drain)	R _{thJC}	- 3.7			C/W			
SPECIFICATIONS (T _J = 25 °C, 0	inless otherwi	ise noted)						
PARAMETER	SYMBOL	1	T CONDIT	IONS	MIN.	TYP.	MAX.	UNI
Static								
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} =	= 0 V, I _D =	250 µA	500	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_J$		e to 25 °C,		-	0.59	-	V/°C
Gate-Source Threshold Voltage (N)	V _{GS(th)}		= V _{GS} , I _D =	-	2.0	-	4.0	V
Gate-Source Leakage	I _{GSS}		$V_{GS} = \pm 20$		-	-	± 100	nA
		$V_{DS} = 500 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$		-	-	1		
Zero Gate Voltage Drain Current	I _{DSS}			/, T _J = 125 °C	-	-	10	μA
Drain-Source On-State Resistance	R _{DS(on)}	$V_{GS} = 10 \text{ V}$ $I_D = 10 \text{ A}$		-	0.160	0.184	Ω	
Forward Transconductance	g _{fs}		= 30 V, I _D :		-	4.4	-	S
Dynamic					1	I	<u> </u>	
Input Capacitance	C _{iss}	V _{GS} = 0 V,		-	1640	-		
Output Capacitance	C _{oss}		$V_{\rm GS} = 0.0,$ $V_{\rm DS} = 100$ V,		-	87	-	
Reverse Transfer Capacitance	C _{rss}	f = 1 MHz		-	6	-	pF	
Effective Output Capacitance, Energy Related ^a	C _{o(er)}	V_{DS} = 0 V to 400 V, V_{GS} = 0 V		-	73	-		
Effective Output Capacitance, Time Related ^b	C _{o(tr)}			-	222	-		
Total Gate Charge	Qg				-	46	92	
Gate-Source Charge	Q _{gs}	V _{GS} = 10 V I _D = 10 A, V _{DS} = 400 V		-	10	-	nC	
Gate-Drain Charge	Q _{gd}				-	19	-	
Turn-On Delay Time	t _{d(on)}	$V_{DD} = 400 \text{ V}, \text{ I}_{D} = 10 \text{ A}, \\ V_{GS} = 10 \text{ V}, \text{ R}_{g} = 9.1 \Omega$		-	17	34	- ns	
Rise Time	t _r			-	27	54		
Turn-Off Delay Time	t _{d(off)}			-	48	96		
Fall Time	t _f			-	25	50		
Gate Input Resistance	Rg	f = 1 MHz, open drain		-	0.83	-	Ω	
Drain-Source Body Diode Characterist	cs							
Continuous Source-Drain Diode Current	ا _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	19	A	
Pulsed Diode Forward Current	I _{SM}			-	-	42		
Diode Forward Voltage	V _{SD}	T _J = 25 °C, I _S = 10 A, V _{GS} = 0 V		-	-	1.2	V	
Reverse Recovery Time	t _{rr}	$T_{J} = 25 \text{ °C}, I_{F} = I_{S} = 10 \text{ A},$ dI/dt = 100 A/ μ s, V _R = 25 V		-	293	-	ns	
Reverse Recovery Charge	Q _{rr}			-	4.0	-	μC	
Reverse Recovery Current	I _{RRM}			-	26	-	Ā	

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .

b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

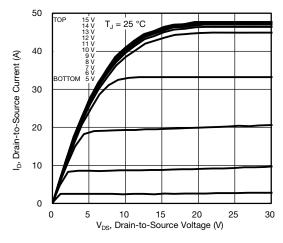


Fig. 1 - Typical Output Characteristics

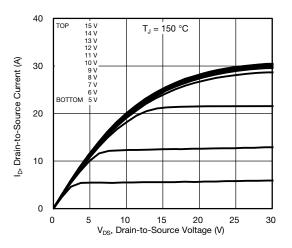


Fig. 2 - Typical Output Characteristics

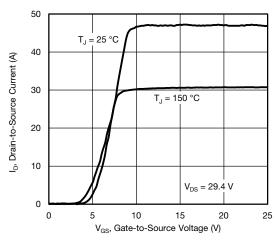


Fig. 3 - Typical Transfer Characteristics

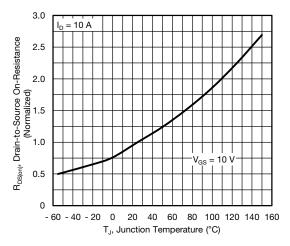


Fig. 4 - Normalized On-Resistance vs. Temperature

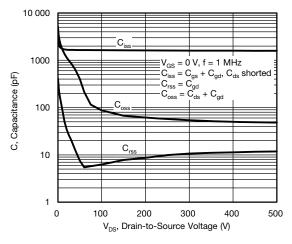


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

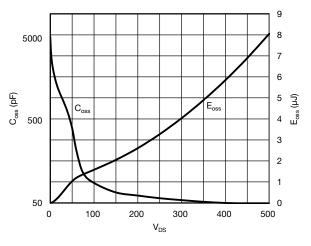


Fig. 6 - C_{oss} and E_{oss} vs. V_{DS}

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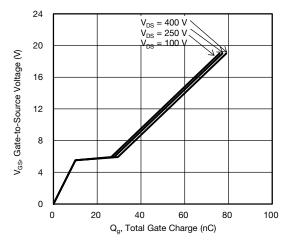


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

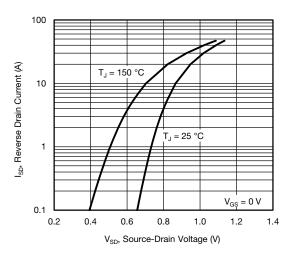


Fig. 8 - Typical Source-Drain Diode Forward Voltage

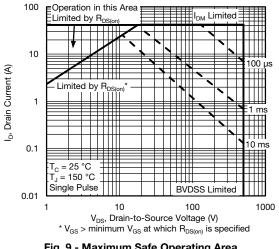


Fig. 9 - Maximum Safe Operating Area

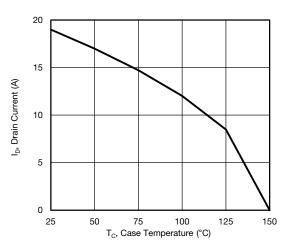


Fig. 10 - Maximum Drain Current vs. Case Temperature

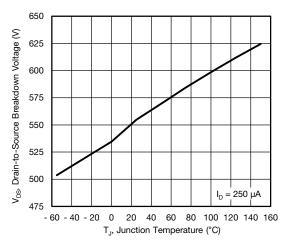


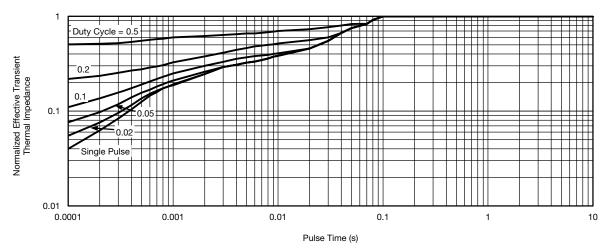
Fig. 11 - Temperature vs. Drain-to-Source Voltage

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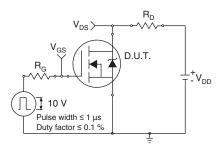


Fig. 13 - Switching Time Test Circuit

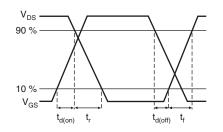


Fig. 14 - Switching Time Waveforms

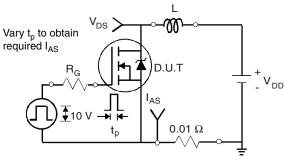


Fig. 15 - Unclamped Inductive Test Circuit

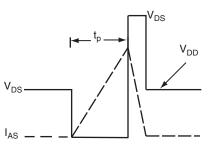


Fig. 16 - Unclamped Inductive Waveforms

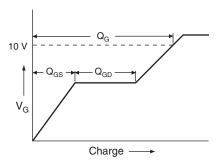


Fig. 17 - Basic Gate Charge Waveform

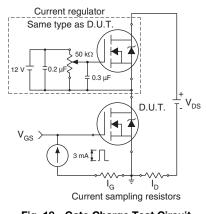


Fig. 18 - Gate Charge Test Circuit

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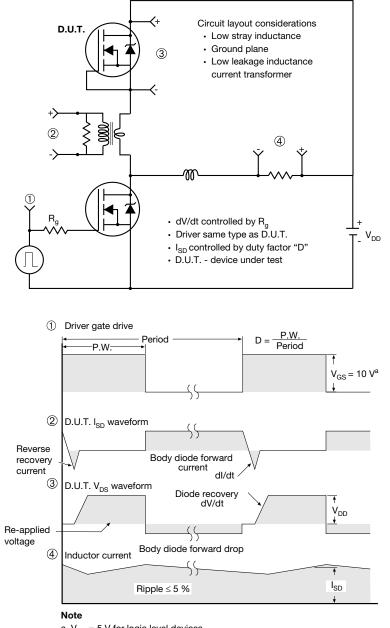
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Peak Diode Recovery dV/dt Test Circuit



a. $V_{GS} = 5 V$ for logic level devices

Fig. 19 - For N-Channel

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